SPEC. NO.: PS-51150-XXXXX-XXX PRODUCT NAME: 0.4mm BTB CO PRODUCT NO: 51150-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XXX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-51151-XX-	ONN. S	SERIES	<u> </u>)
PRODUCT NO: 51150-XXXXX- 51151-XXXXX- PREPARED: CHECKE DATE: DATE:	ONN. S	SERIES	/R S/T TYP)
PRODUCT NO: 51150-XXXXX- 51151-XXXXX- PREPARED: CHECKE DATE: DATE:	ONN. S	SERIES	/R S/T TYP		
PRODUCT NO: 51150-XXXXX-51151-XXXXX- PREPARED: CHECKE DATE: DATE:	-XXX S	SERIES	<u> </u>	PE	
PREPARED: CHECKE DATE: DATE:					
DATE: DATE:					
DATE: DATE:					
	ED:		APPI	ROVED:	
2010/00/21	2016/09	9/21	DAT	E: 2016/0	99/21
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Aces P/N: 51150 Series TITLE: 0.4 MM BTB CONN. SMT D/R S/T TYPE RELEASE DATE: 2016/09/21 ECN No: 1609326 REVISION: O PAGE: 2 OF 9 1 2 APPLICABLE DOCUMENTS 4 3 REQUIREMENTS 4 4 5 PERFORMANCE 5 6 PRODUCT QUALIFICATION AND TEST SEQUENCE...... 8 8 9

TLE: 0.4 MM BTB CONN. SMT D/R S/T TYPE ASE DATE: 2018/09/21 REVISION: O ECN No: 1609326 PAGE: 3 OF 9 Revision History Rev. ECN # Revision Description Prepared Date			Aces P/N: 51150 Ser	ies
Revision History	ITLE: 0.	4 MM BTB CONN	SMT D/R S/T TYPE	
	EASE DAT	E: 2016/09/21	REVISION: O ECN No: 1	609326 PAGE: 3 OF 9
	Revis	ion History		
O 1609326 FOR PDR APD1000321 NEW REV ALEX 2016/09/21			Revision Description	Prepared Date
		1609326	FOR PDR APD1000321 NEW REV	ALEX 2016/09/21

A D/NI	E44E0	aariaa
Aces P/N:	51150	261162

TITLE: 0.4 MM BTB CONN. SMT D/R S/T TYPE

2 SCOPE

This specification covers performance, tests and quality requirements for 0.4 mm BTB CONN, SMT D/R S/T TYPE

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: (a) Contact Area: Refer to the drawing.

- (b) Under plate: Refer to the drawing.
- (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Fitting Nail: Copper Alloy, Finish: Refer to the drawing.
- 4.3 Ratings
 - 4.3.1 Working Voltage Less than 36 Volts AC(Per Pin)
 - 4.3.2 Voltage: 50 Volts AC/DC (per pin)
 - 4.3.3 Current: 0.5 Amperes (per pin)
 - 4.3.4 Operating Temperature : -40°C to +80°C

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
	Product shall meet requirements of	Visual, dimensional and functional
Examination of Product	applicable product drawing and	per applicable quality inspection
	specification.	plan.
	ELECTRICAL	
Item	Requirement	Standard
Low Level Contact Resistance	70 m Ω Max.(initial)per contact 20 m Ω Max.change allowed	Mate connectors, measure by dry circuit, 20mV Max., 10mA Max. (EIA-364-23)
Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 250 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	250 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)
	MECHANICAL	
Item	Requirement	Standard
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)
Mating/Unmating Forces	See Figure 1	Operation Speed: 10 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13)
Terminal / Housing Retention Force (Rcpt. CONN.)	2 Pin 0.15kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.
Fitting Nail /Housing Retention Force (Plug/Rcpt. CONN.)	0.15kgf MIN.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.

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Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

ENVIRONMENTAL							
Item	Requirement	Standard					
Resistance to Reflow Soldering Heat	See Product Qualification and Test (Lead Free)	Pre Heat: 150°C ~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max.					
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 ℃, 30 minutes +85 +3/-0 ℃, 30 minutes (EIA-364-32, test condition I)					
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)					
Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)					

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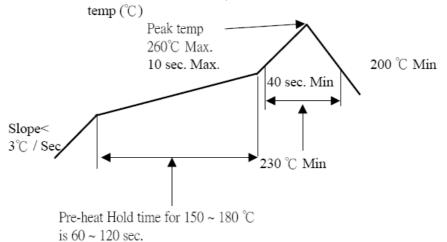
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.

Note. Flowing Mixed Gas shell be conduct by customer request.

6 INFRARED REFLOW CONDITION

6.1. Lead-Free Process

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)



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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

					Te	st Gro	up			
Test or Examination	1	2	3	4	5	6	7	8	9	
					Test	Sequ	ence			
Examination of Product	1,3	1	1	1 . 7	1 \ 6	1 \ 4			1,3	
Low Level Contact Resistance		2 · 6	2 · 5	2 · 8	2 · 7	2 · 5				
Insulation Resistance				3 · 9	3 · 8					
Dielectric Withstanding Voltage				4 · 10	4 • 9					
Temperature rise	2									
Mating / Unmating Forces		3 . 5								
Durability		4								
Vibration			3							
Shock (Mechanical)			4							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray(Only For Gold Plating)						3				
Solder ability							1			
Terminal / Housing Retention Force (Rcpt. CONN.)								1		
Fitting Nail /Housing Retention Force (PLUG/Rcpt. CONN.)								2		
Hand Soldering Temperature Resistance									2	
Sample Size	2	4	4	4	4	4	2	4	4	

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8 MATTING/UNMATTING FORCE

Unit: N/Kg

Number of	Mating force N/Kg Max.				Unmating force N/Kg Min.			
circuits	intial		30 th		intial		30 th	
	N	Kg	N	Kg	N	Kg	N	Kg
30	20.58	2.1	16.17	1.65	98	1.0	98	1.0

9. CONNECTOR USAGE

